

# MM3Z2V0~MM3Z75

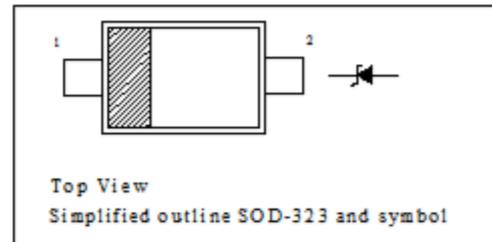
## SILICON PLANAR ZENER DIODES

### Features

- Total power dissipation : max. 300 mW
- Small plastic package suitable for surface mounted design
- Tolerance approximately  $\pm 5\%$

### PINNING

P I N	DESCRIPTION
1	Cathode
2	Anode

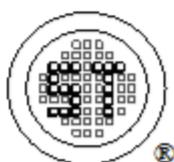


.....  $T_A = 25 \text{ }^\circ\text{C}$

Parameter	Symbol	Value	Unit
Power Dissipation	$P_{tot}$	300	mW
Junction Temperature	$T_j$	150	$^\circ\text{C}$
Storage Temperature Range	$T_s$	- 55 to + 150	$^\circ\text{C}$

.....  $T_A = 25 \text{ }^\circ\text{C}$

Parameter	Symbol	Max.	Unit
Thermal Resistance Junction to Ambient Air	$R_{thA}$	0.3	K/W
Forward Voltage at $I_F = 10 \text{ mA}$	$V_F$	0.9	V



**SEMTECH ELECTRONICS LTD.**

(Subsidiary of Sino-Tech International Holdings Limited, a company  
listed on the Hong Kong Stock Exchange, Stock Code: 724)



ISO/TS 19949:2002 Certificate No. D8128  
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ISO 9001:2000 Certificate No. 050628

Dated : 09/11/2007

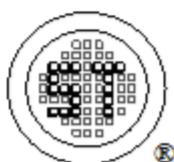
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.....  $T_a = 25 \text{ }^\circ\text{C}$

Type	Marking Code	Zener Voltage Range <sup>1)</sup>			Dynamic Impedance <sup>2)</sup>		Reverse Leakage Current	
		V <sub>nom</sub> V	I <sub>ZT</sub> mA	for V <sub>ZT</sub> V	Z <sub>ZT</sub> (Max.) at $\Omega$	I <sub>ZT</sub> mA	I <sub>R</sub> (Max.) $\mu\text{A}$	at V <sub>R</sub> V
MM3Z2V0	B0	2.0	5	1.8...2.15	100	5	120	0.5
MM3Z2V2	C0	2.2	5	2.08...2.33	100	5	120	0.7
MM3Z2V4	1C	2.4	5	2.28...2.56	100	5	120	1
MM3Z2V7	1D	2.7	5	2.5...2.9	110	5	120	1
MM3Z3V0	1E	3.0	5	2.8...3.2	120	5	50	1
MM3Z3V3	1F	3.3	5	3.1...3.5	130	5	20	1
MM3Z3V6	1H	3.6	5	3.4...3.8	130	5	10	1
MM3Z3V9	1J	3.9	5	3.7...4.1	130	5	5	1
MM3Z4V3	1K	4.3	5	4...4.6	130	5	5	1
MM3Z4V7	1M	4.7	5	4.4...5	130	5	2	1
MM3Z5V1	1N	5.1	5	4.8...5.4	130	5	2	1.5
MM3Z5V6	1P	5.6	5	5.2...6	80	5	1	2.5
MM3Z6V2	1R	6.2	5	5.8...6.6	50	5	1	3
MM3Z6V8	1X	6.8	5	6.4...7.2	30	5	0.5	3.5
MM3Z7V5	1Y	7.5	5	7...7.9	30	5	0.5	4
MM3Z8V2	1Z	8.2	5	7.7...8.7	30	5	0.5	5
MM3Z9V1	2A	9.1	5	8.5...9.6	30	5	0.5	6
MM3Z10	2B	10	5	9.4...10.6	30	5	0.1	7
MM3Z11	2C	11	5	10.4...11.6	30	5	0.1	8
MM3Z12	2D	12	5	11.4...12.7	35	5	0.1	9
MM3Z13	2E	13	5	12.4...14.1	35	5	0.1	10
MM3Z15	2F	15	5	13.8...15.6	40	5	0.1	11
MM3Z16	2H	16	5	15.3...17.1	40	5	0.1	12
MM3Z18	2J	18	5	16.8...19.1	45	5	0.1	13
MM3Z20	2K	20	5	18.8...21.2	50	5	0.1	15
MM3Z22	2M	22	5	20.8...23.3	55	5	0.1	17
MM3Z24	2N	24	5	22.8...25.6	60	5	0.1	19
MM3Z27	2P	27	5	25.1...28.9	70	2	0.1	21
MM3Z30	2R	30	5	28...32	80	2	0.1	23
MM3Z33	2X	33	5	31...35	80	2	0.1	25
MM3Z36	2Y	36	5	34...38	90	2	0.1	27
MM3Z39	2Z	39	2.5	37...41	100	2	2	30
MM3Z43	3A	43	2.5	40...46	130	2	2	33
MM3Z47	3B	47	2.5	44...50	150	2	2	36
MM3Z51	3C	51	2.5	48...54	180	2	1	39
MM3Z56	3D	56	2.5	52...60	180	2	1	43
MM3Z62	3E	62	2.5	58...66	200	2	0.2	47
MM3Z68	3F	68	2.5	64...72	250	2	0.2	52
MM3Z75	3H	75	2.5	70...79	300	2	0.2	57

<sup>1)</sup> V<sub>Z</sub> is tested with pulses (20 ms).

<sup>2)</sup> Z<sub>ZT</sub> is measured at I<sub>ZT</sub> by given a very small A.C. current signal.



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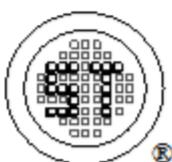
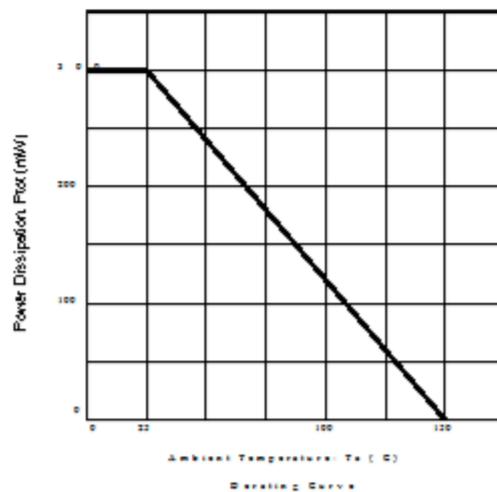
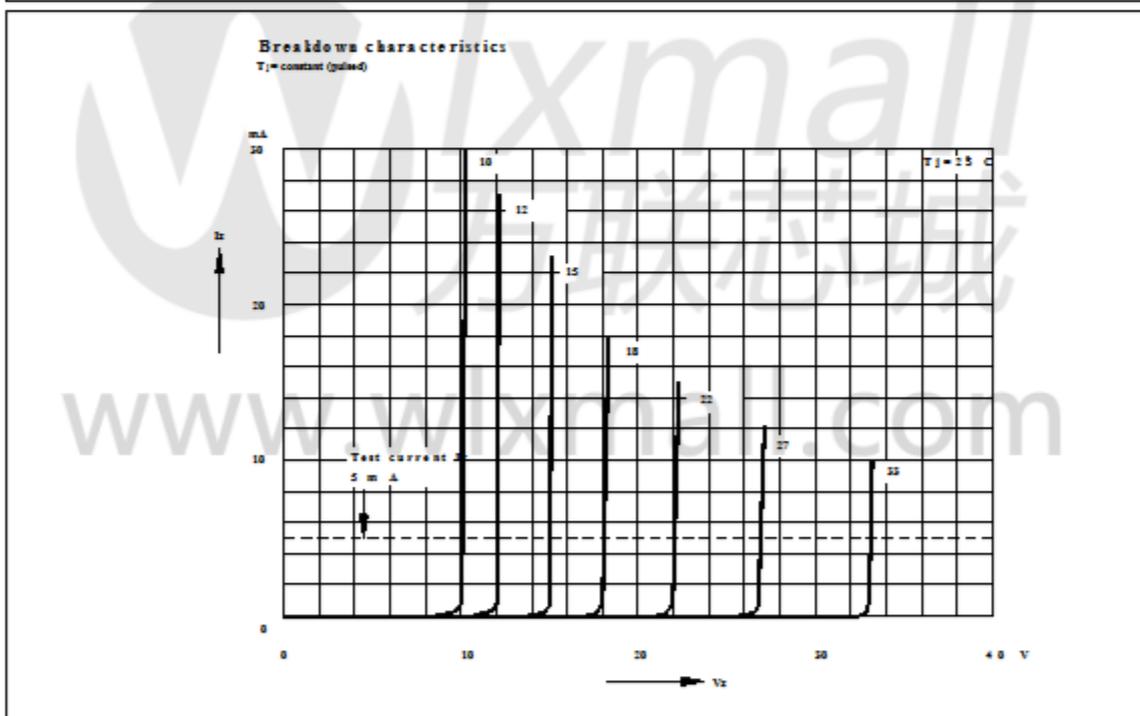
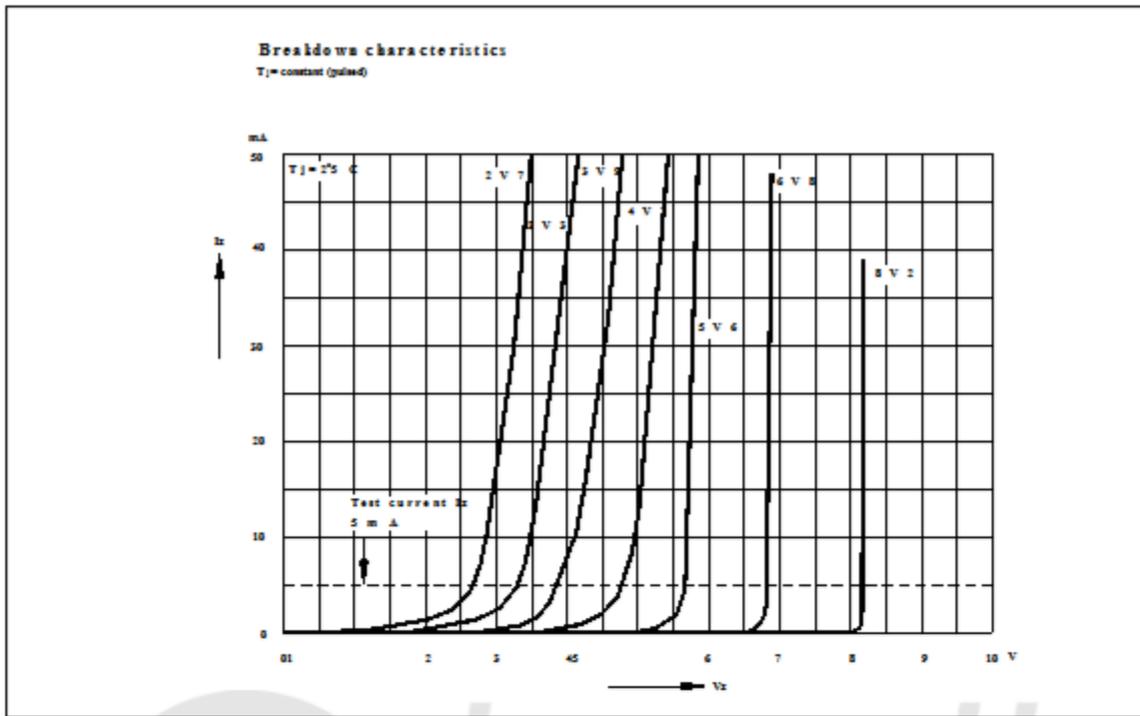
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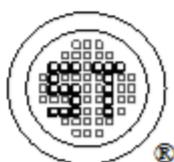
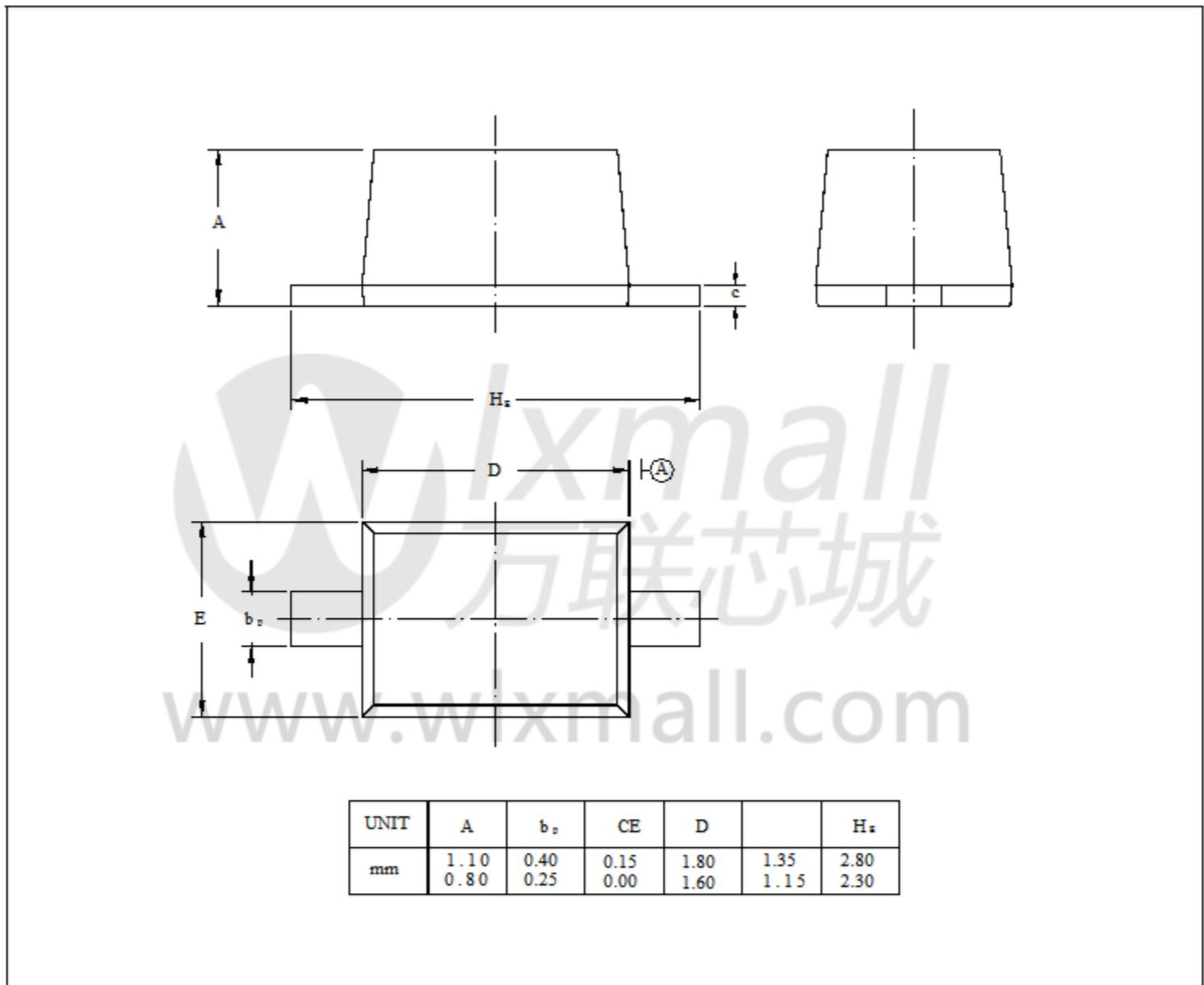


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PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SOD-323



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